

FEATURES

- 10 years minimum data retention in the absence of external power
- Data is automatically protected during power loss
- Directly replaces 2k x 8 volatile static RAM or EEPROM
- Unlimited write cycles
- Low-power CMOS
- JEDEC standard 24-pin DIP package
- Read and write access times as fast as 100 ns
- Lithium energy source is electrically disconnected to retain freshness until power is applied for the first time
- Full $\pm 10\%$ V_{CC} operating range (DS1220AD)
- Optional $\pm 5\%$ V_{CC} operating range (DS1220AB)
- Optional industrial temperature range of -40°C to $+85^{\circ}\text{C}$, designated IND

PIN ASSIGNMENT

| | | | |
|-----|----|----|------------------------|
| A7 | 1 | 24 | VCC |
| A6 | 2 | 23 | A8 |
| A5 | 3 | 22 | $\overline{\text{A9}}$ |
| A4 | 4 | 21 | $\overline{\text{WE}}$ |
| A3 | 5 | 20 | $\overline{\text{OE}}$ |
| A2 | 6 | 19 | A10 |
| A1 | 7 | 18 | $\overline{\text{CE}}$ |
| A0 | 8 | 17 | DQ7 |
| DQ0 | 9 | 16 | DQ6 |
| DQ1 | 10 | 15 | DQ5 |
| DQ2 | 11 | 14 | DQ4 |
| GND | 12 | 13 | DQ3 |

24-Pin ENCAPSULATED PACKAGE
 720-mil EXTENDED

PIN DESCRIPTION

| | |
|------------------------|--------------------|
| A0-A10 | - Address Inputs |
| DQ0-DQ7 | - Data In/Data Out |
| $\overline{\text{CE}}$ | - Chip Enable |
| $\overline{\text{WE}}$ | - Write Enable |
| $\overline{\text{OE}}$ | - Output Enable |
| V_{CC} | - Power (+5V) |
| GND | - Ground |

DESCRIPTION

The DS1220AB and DS1220AD 16k Nonvolatile SRAMs are 16,384-bit, fully static, nonvolatile SRAMs organized as 2048 words by 8 bits. Each NV SRAM has a self-contained lithium energy source and control circuitry which constantly monitors V_{CC} for an out-of-tolerance condition. When such a condition occurs, the lithium energy source is automatically switched on and write protection is unconditionally enabled to prevent data corruption. The NV SRAMs can be used in place of existing 2k x 8 SRAMs directly conforming to the popular byte-wide 24-pin DIP standard. The devices also match the pinout of the 2716 EPROM and the 2816 EEPROM, allowing direct substitution while enhancing performance. There is no limit on the number of write cycles that can be executed and no additional support circuitry is required for microprocessor interfacing.

READ MODE

The DS1220AB and DS1220AD execute a read cycle whenever \overline{WE} (Write Enable) is inactive (high) and \overline{CE} (Chip Enable) and \overline{OE} (Output Enable) are active (low). The unique address specified by the 11 address inputs (A0-A10) defines which of the 2048 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that the \overline{CE} and \overline{OE} access times are also satisfied. If \overline{CE} and \overline{OE} access times are not satisfied, then data access must be measured from the later-occurring signal and the limiting parameter is either t_{CO} for \overline{CE} or t_{OE} for \overline{OE} rather than address access.

WRITE MODE

The DS1220AB and DS1220AD execute a write cycle whenever the \overline{WE} and \overline{CE} signals are active (low) after address inputs are stable. The latter occurring falling edge of \overline{CE} or \overline{WE} will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of \overline{CE} or \overline{WE} . All address inputs must be kept valid throughout the write cycle. \overline{WE} must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The \overline{OE} control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled (\overline{CE} and \overline{OE} active) then \overline{WE} will disable the outputs in t_{ODW} from its falling edge.

DATA RETENTION MODE

The DS1220AB provides full functional capability for V_{CC} greater than 4.75 volts and write protects by 4.5V. The DS1220AD provides full functional capability for V_{CC} greater than 4.5 volts and write protects by 4.25V. Data is maintained in the absence of V_{CC} without any additional support circuitry. The nonvolatile static RAMs constantly monitor V_{CC} . Should the supply voltage decay, the NV SRAMs automatically write protect themselves, all inputs become “don’t care,” and all outputs become high impedance. As V_{CC} falls below approximately 3.0 volts, a power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when V_{CC} rises above approximately 3.0 volts, the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.75 volts for the DS1220AB and 4.5 volts for the DS1220AD.

FRESHNESS SEAL

Each DS1220 device is shipped from Dallas Semiconductor with its lithium energy source disconnected, guaranteeing full energy capacity. When V_{CC} is first applied at a level of greater than V_{TP} , the lithium energy source is enabled for battery backup operation.

ABSOLUTE MAXIMUM RATINGS*

| | |
|---------------------------------------|--|
| Voltage on Any Pin Relative to Ground | -0.3V to +7.0V |
| Operating Temperature | 0°C to 70°C; -40°C to +85°C for IND parts |
| Storage Temperature | -40°C to +70°C; -40°C to +85°C for IND parts |
| Soldering Temperature | 260°C for 10 seconds |

* This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS (T_A: See Note 10)

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------------|-----------------|------|-----|-----------------|-------|-------|
| DS 1220AB Power Supply Voltage | V _{CC} | 4.75 | 5.0 | 5.25 | V | |
| DS 1220AD Power Supply Voltage | V _{CC} | 4.50 | 5.0 | 5.50 | V | |
| Logic 1 | V _{IH} | 2.2 | | V _{CC} | V | |
| Logic 0 | V _{IL} | 0.0 | | +0.8 | V | |

(V_{CC} = 5V ± 5% for DS1220AB)

(T_A: See Note 10)

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5V ± 10% for DS1220AD)

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|---|-------------------|------|------|------|-------|-------|
| Input Leakage Current | I _{IL} | -1.0 | | +1.0 | μA | |
| I/O Leakage Current CE ≥ V _{IH} ≤ V _{CC} | I _{IO} | -1.0 | | +1.0 | μA | |
| Output Current @ 2.4V | I _{OH} | -1.0 | | | mA | |
| Output Current @ 0.4V | I _{OL} | 2.0 | | | mA | |
| Standby Current CE = 2.2V | I _{CCS1} | | 5.0 | 10.0 | mA | |
| Standby Current CE = V _{CC} -0.5V | I _{CCS2} | | 3.0 | 5.0 | mA | |
| Operating Current t _{CYC} =200 ns (Commercial) | I _{CCO1} | | | 75 | mA | |
| Operating Current t _{CYC} =200ns (Industrial) | I _{CCO1} | | | 85 | mA | |
| Write Protection Voltage (DS1220AB) | V _{TP} | 4.5 | 4.62 | 4.75 | V | |
| Write Protection Voltage (DS1220AD) | V _{TP} | 4.25 | 4.37 | 4.5 | V | |

CAPACITANCE (T_A = 25°C)

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|------------------|-----|-----|-----|-------|-------|
| Input Capacitance | C _{IN} | | 5 | 10 | pF | |
| Input/Output Capacitance | C _{I/O} | | 5 | 12 | pF | |

(V_{CC} = 5.0V ± 5% for DS1220AB)(T_A: See Note 10)**AC ELECTRICAL CHARACTERISTICS**(V_{CC} = 5.0V ± 10% for DS1220AD)

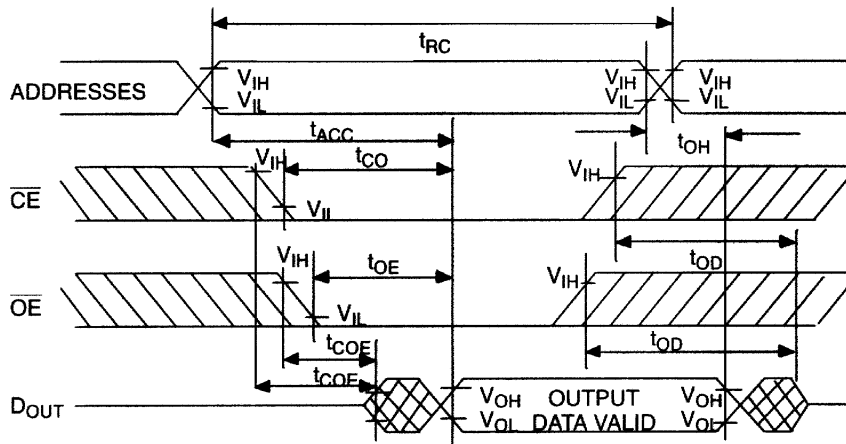
| PARAMETER | SYMBOL | DS1220AB-100 DS1220AD-100 | | DS1220AB-120 DS1220AD-120 | | UNITS | NOTES |
|---|------------------|------------------------------|-----|------------------------------|-----|-------|-------|
| | | MIN | MAX | MIN | MAX | | |
| Read Cycle Time | t _{RC} | 100 | | 120 | | ns | |
| Access Time | t _{ACC} | | 100 | | 120 | ns | |
| $\overline{\text{OE}}$ to Output Valid | t _{OE} | | 50 | | 60 | ns | |
| $\overline{\text{CE}}$ to Output Valid | t _{CO} | | 100 | | 120 | ns | |
| $\overline{\text{OE}}$ or $\overline{\text{CE}}$ to Output Active | t _{COE} | 5 | | 5 | | ns | 5 |
| Output High Z from Deselection | t _{OD} | | 35 | | 35 | ns | 5 |
| Output Hold from Address Change | t _{OH} | 5 | | 5 | | ns | |
| Write Cycle Time | t _{WC} | 100 | | 120 | | ns | |
| Write Pulse Width | t _{WP} | 75 | | 90 | | ns | 3 |
| Address Setup Time | t _{AW} | 0 | | 0 | | ns | |
| Write Recovery Time | t _{WR1} | 0 | | 0 | | ns | 12 |
| | t _{WR2} | 10 | | 10 | | ns | 13 |
| Output High from $\overline{\text{WE}}$ | t _{ODW} | | 35 | | 35 | ns | 5 |
| Output Active from $\overline{\text{WE}}$ | t _{OEW} | 5 | | 5 | | ns | 4 |
| Data Setup Time | t _{DS} | 40 | | 50 | | ns | 4 |
| Data Hold Time | t _{DH1} | 0 | | 0 | | ns | 12 |
| | t _{DH2} | 10 | | 10 | | ns | 13 |

AC ELECTRICAL CHARACTERISTICS

(cont'd)

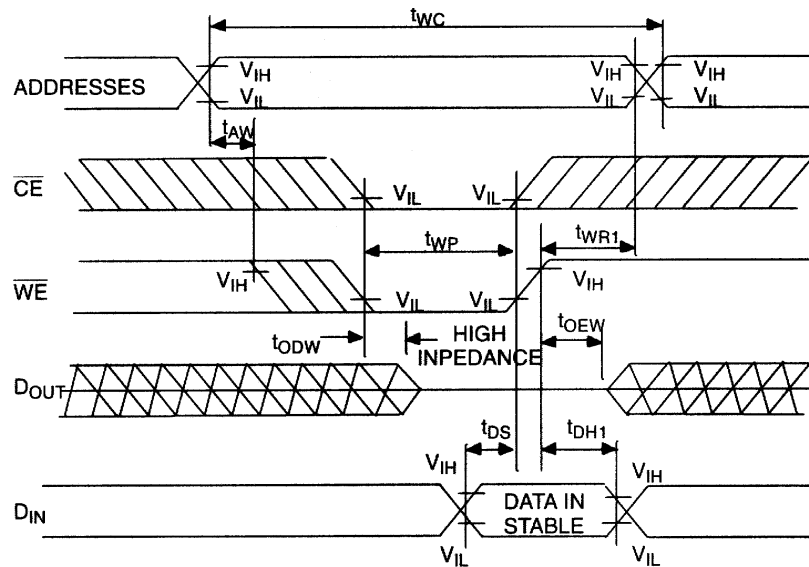
| PARAMETER | SYMBOL | DS1220AB-150 DS1220AD-150 | | DS1220AB-200 DS1220AD-200 | | UNITS | NOTES |
|---|-----------|------------------------------|-----|------------------------------|-----|-------|-------|
| | | MIN | MAX | MIN | MAX | | |
| Read Cycle Time | t_{RC} | 150 | | 200 | | ns | |
| Access Time | t_{ACC} | | 150 | | 200 | ns | |
| \overline{OE} to Output Valid | t_{OE} | | 70 | | 100 | ns | |
| \overline{CE} to Output Valid | t_{CO} | | 150 | | 200 | ns | |
| \overline{OE} or \overline{CE} to Output Active | t_{COE} | 5 | | 5 | | ns | 5 |
| Output High Z from Deselection | t_{OD} | | 35 | | 35 | ns | 5 |
| Output Hold from Address Change | t_{OH} | 5 | | 5 | | ns | |
| Write Cycle Time | t_{WC} | 150 | | 200 | | ns | |
| Write Pulse Width | t_{WP} | 100 | | 150 | | ns | 3 |
| Address Setup Time | t_{AW} | 0 | | 0 | | ns | |
| Write Recovery Time | t_{WR1} | 0 | | 0 | | ns | 12 |
| | t_{WR2} | 10 | | 10 | | ns | 13 |
| Output High Z from \overline{WE} | t_{ODW} | | 35 | | 35 | ns | 5 |
| Output Active from \overline{WE} | t_{OEW} | 5 | | 5 | | ns | 4 |
| Data Setup Time | t_{DS} | 60 | | 50 | | ns | 4 |
| Data Hold Time | t_{DH1} | 0 | | 0 | | ns | 12 |
| | t_{DH2} | 10 | | 10 | | ns | 13 |

READ CYCLE



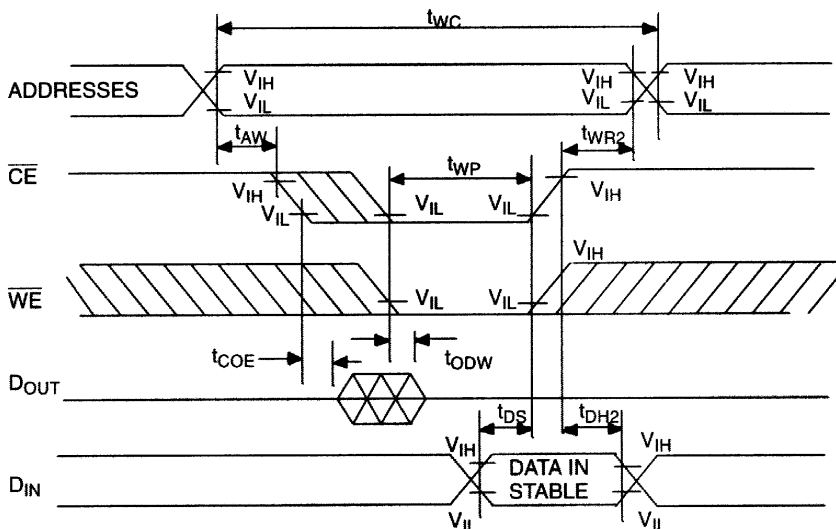
SEE NOTE 1

WRITE CYCLE 1



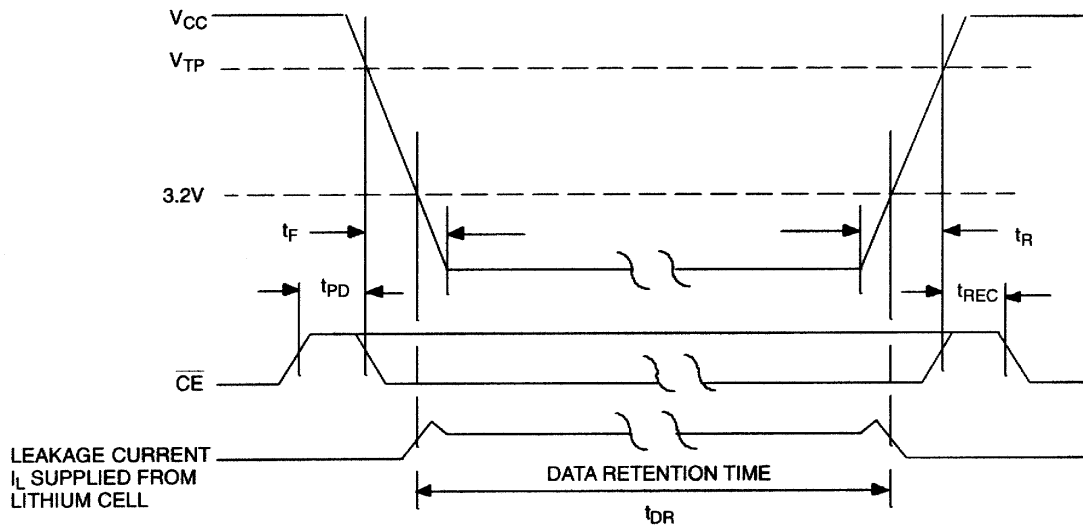
SEE NOTES 2, 3, 4, 6, 7, 8 AND 12

WRITE CYCLE 2



SEE NOTES 2, 3, 4, 6, 7, 8 AND 13

POWER-DOWN/POWER-UP CONDITION



SEE NOTE 11

POWER-DOWN/POWER-UP TIMING

 $(t_A: \text{See Note 10})$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|---|-----------|-----|-----|-----|---------------|-------|
| \overline{CE} at V_{IH} before Power-Down | t_{PD} | 0 | | | μs | 11 |
| V_{CC} slew from V_{TP} to 0V | t_F | 300 | | | μs | |
| V_{CC} slew from 0V to V_{TP} | t_R | 300 | | | μs | |
| \overline{CE} at V_{IH} after Power-Up | t_{REC} | 2 | | 125 | ms | |

 $(T_A = 25^\circ\text{C})$

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNITS | NOTES |
|------------------------------|----------|-----|-----|-----|-------|-------|
| Expected Data Retention Time | t_{DR} | 10 | | | years | 9 |

WARNING:

Under no circumstances are negative undershoots, of any amplitude, allowed when device is in the battery backup mode.

NOTES:

- \overline{WE} is high for a read cycle.
- $\overline{OE} = V_{IH}$ or V_{IL} . If $\overline{OE} = V_{IH}$ during write cycle, the output buffers remain in a high-impedance state.
- t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE} or \overline{WE} going low to the earlier of \overline{CE} or \overline{WE} going high.
- t_{DS} is measured from the earlier of \overline{CE} or \overline{WE} going high.
- These parameters are sampled with a 5 pF load and are not 100% tested.
- If the \overline{CE} low transition occurs simultaneously with or later than the \overline{WE} low transition, the output buffers remain in a high-impedance state during this period.

7. If the $\overline{\text{CE}}$ high transition occurs prior to or simultaneously with the $\overline{\text{WE}}$ high transition, the output buffers remain in a high-impedance state during this period.
8. If $\overline{\text{WE}}$ is low or the $\overline{\text{WE}}$ low transition occurs prior to or simultaneously with the $\overline{\text{CE}}$ low transition, the output buffers remain in a high-impedance state during this period.
9. Each DS1220AB and each DS1220AD has a built-in switch that disconnects the lithium source until V_{CC} is first applied by the user. The expected t_{DR} is defined as accumulative time in the absence of V_{CC} starting from the time power is first applied by the user.
10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C . For industrial products (IND), this range is -40°C to $+85^{\circ}\text{C}$.
11. In a power down condition the voltage on any pin may not exceed the voltage on V_{CC} .
12. t_{WR1} , t_{DH1} are measured from $\overline{\text{WE}}$ going high.
13. t_{WR2} , t_{DH2} are measured from $\overline{\text{CE}}$ going high.
14. DS1220AB and DS1220AD modules are recognized by Underwriters Laboratory (U.L.®) under file E99151.

DC TEST CONDITIONS

Outputs Open

All Voltages Are Referenced to Ground

AC TEST CONDITIONS

Output Load: 100 pF + 1TTL Gate

Input Pulse Levels: 0 - 3.0V

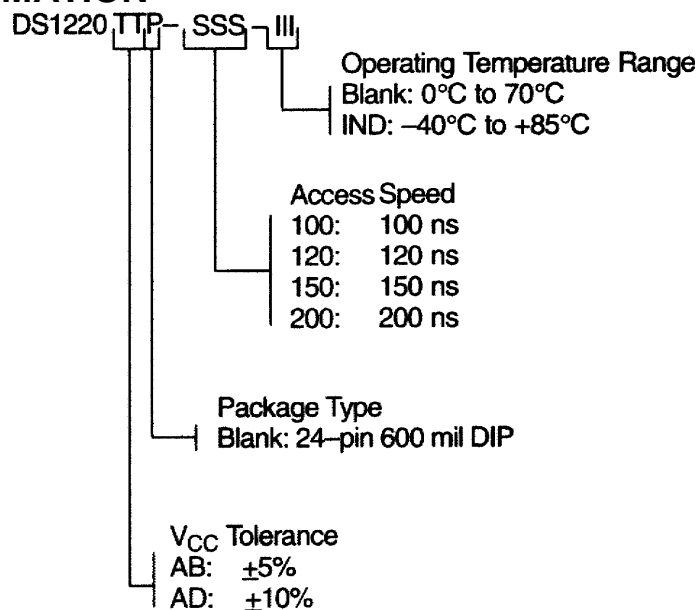
Timing Measurement Reference Levels

Input: 1.5V

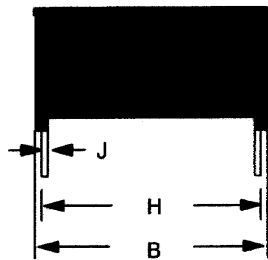
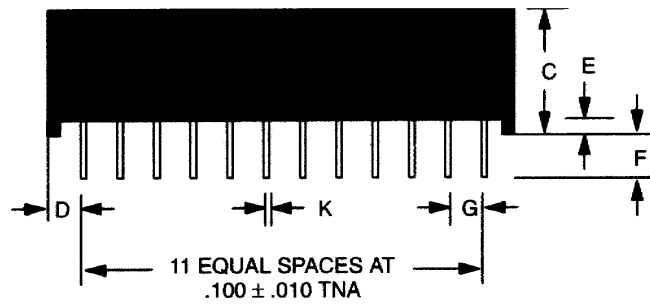
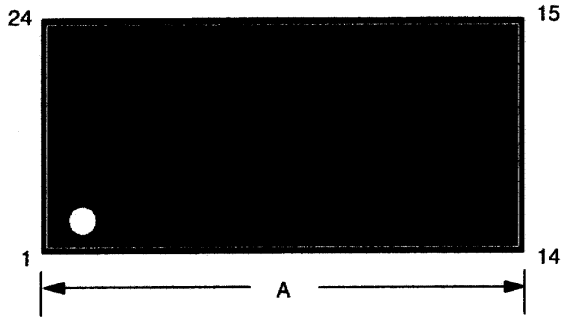
Output: 1.5V

Input Pulse Rise and Fall Times: 5ns

ORDERING INFORMATION



DS1220AB/AD NONVOLATILE SRAM, 24-PIN 720-MIL EXTENDED MODULE



| PKG DIM | 24-PIN | |
|------------|--------|-------|
| | MIN | MAX |
| A IN. | 1.320 | 1.340 |
| MM | 33.53 | 34.04 |
| B IN. | 0.695 | 0.720 |
| MM | 17.65 | 18.29 |
| C IN. | 0.390 | 0.415 |
| MM | 9.91 | 10.54 |
| D IN. | 0.100 | 0.130 |
| MM | 2.54 | 3.30 |
| E IN. | 0.017 | 0.030 |
| MM | 0.43 | 0.76 |
| F IN. | 0.120 | 0.160 |
| MM | 3.05 | 4.06 |
| G IN. | 0.090 | 0.110 |
| MM | 2.29 | 2.79 |
| H IN. | 0.590 | 0.630 |
| MM | 14.99 | 16.00 |
| J IN. | 0.008 | 0.012 |
| MM | 0.20 | 0.30 |
| K IN. | 0.015 | 0.021 |
| MM | 0.38 | 0.53 |

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